

Data sheet Product ICK LED R 35 x 10 G



Heatsinks and active heatsinks for processors>Heatsinks for LEDs
 Ø 35 x 10 mm, for IC design LED

Features

diameter:	35 mm
way of fixation:	<ul style="list-style-type: none"> • therm. conductive foil • therm. cond. adhesive
height:	10 mm
plate thickness:	2.5 mm
thermal resistance:	17.5 - 3.6 K/W
dissipation loss:	9.2 W
surface:	black anodised

Technical Drawing

